

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT3258585

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT

**CONVEYING PARTY DATA**

Name	Execution Date
YUKIO KASHIMA	02/03/2015
ERIKO MATSUURA	02/03/2015
MITSUNORI KOKUBO	01/27/2015
TAKAHARU TASHIRO	01/26/2015
TAKAFUMI OOKAWA	01/22/2015
HIDEKI HIRAYAMA	01/26/2015
RYUICHIRO KAMIMURA	01/22/2015
YAMATO OSADA	01/22/2015
SATOSHI SHIMATANI	02/02/2015

**RECEIVING PARTY DATA**

<b>Name:</b>	MARUBUN CORPORATION
<b>Street Address:</b>	8-1, NIHONBASHI ODENMACHO, CHUO-KU
<b>City:</b>	TOKYO
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	103-8577
<b>Name:</b>	TOSHIBA KIKAI KABUSHIKI KAISHA
<b>Street Address:</b>	2-2, UCHISAIWAICHO 2-CHOME, CHIYODA-KU
<b>City:</b>	TOKYO
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	100-8503
<b>Name:</b>	RIKEN
<b>Street Address:</b>	2-1, HIROSAWA
<b>City:</b>	WAKO-SHI, SAITAMA
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	351-0198
<b>Name:</b>	ULVAC, INC.
<b>Street Address:</b>	2500, HAGISONO,
<b>City:</b>	CHIGASAKI-SHI, KANAGAWA
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	253-8543

PATENT

<b>Name:</b>	TOKYO OHKA KOGYO CO., LTD.
<b>Street Address:</b>	150, NAKAMARUKO, NAKAHARA-KU,
<b>City:</b>	KAWASAKI-SHI, KANAGAWA
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	211-0012

**PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14426328

**CORRESPONDENCE DATA**

**Fax Number:** (612)455-3801

*Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.*

**Phone:** 6124553800

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**Correspondent Name:** HAMRE, SCHUMANN, MUELLER & LARSON, P.C.

**Address Line 1:** P.O. BOX 2902

**Address Line 4:** MINNEAPOLIS, MINNESOTA 55402

**ATTORNEY DOCKET NUMBER:** 20219.0017USWO

**NAME OF SUBMITTER:** DOUGLAS P. MUELLER

**SIGNATURE:** /Douglas P. Mueller/

**DATE SIGNED:** 03/10/2015

**Total Attachments: 15**

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Docket No. 20219.0017USWO

## ASSIGNMENT OF PATENT APPLICATION

WHEREAS,

1. Yukio KASHIMA having an address of c/o Marubun Corporation, 8-1, Nihonbashi Odenmachi, Chuo-ku, Tokyo 103-8577 Japan and a citizen of Japan
2. Eriko MATSUURA having an address of c/o Marubun Corporation, 8-1, Nihonbashi Odenmachi, Chuo-ku, Tokyo 103-8577 Japan and a citizen of Japan
3. Mitsunori KOKUBO having an address of c/o Toshiba Kikai Kabushiki Kaisha, 2068-3, Ooka, Numazu-shi, Shizuoka 410-8510 Japan and a citizen of Japan
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6. Hideki HIRAYAMA having an address of c/o RIKEN, 2-1, Hirosawa, Wako-shi, Saitama 351-0198 Japan and a citizen of Japan
7. Ryuichiro KAMIMURA having an address of c/o ULVAC, INC., Institute of Semiconductor & Electronics Technologies, 1220-1, Suyama, Susono-shi, Shizuoka 410-1231 Japan and a citizen of Japan
8. Yamato OSADA having an address of c/o ULVAC, INC., Institute of Semiconductor & Electronics Technologies, 1220-1, Suyama, Susono-shi, Shizuoka 410-1231 Japan and a citizen of Japan
9. Satoshi SHIMATANI having an address of c/o Tokyo Ohka Kogyo Co., Ltd., 150, Nakamaruko, Nakahara-ku, Kawasaki-shi, Kanagawa 211-0012 Japan and a citizen of Japan

(hereinafter called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States for this invention which was filed on October 24, 2014, entitled  
DEEP ULTRAVIOLET LED AND METHOD FOR MANUFACTURING THE SAME,  
and which has been given application serial number PCT/JP2014/078308;

and

WHEREAS, (1) MARUBUN CORPORATION; (2) TOSHIBA KIKAI KABUSHIKI KAISHA; (3) RIKEN; (4) ULVAC, INC.; and (5) TOKYO OHKA KOGYO CO., LTD. (hereinafter "ASSIGNEE") a corporation organized under the laws of Japan and having an office and place of business at (1) 8-1, Nihonbashi Odenmachi, Chuo-ku, Tokyo 103-8577 Japan; (2) 2-2, Uchisaiwaicho 2-chome, Chiyoda-ku, Tokyo 100-8503 Japan; (3) 2-1, Hirosawa, Wako-shi, Saitama 351-0198 Japan; (4) 2500, Hagisono, Chigasaki-shi, Kanagawa 253-8543 Japan; and (5) 150, Nakamaruko, Nakahara-ku, Kawasaki-shi, Kanagawa 211-0012 Japan

wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;



\_\_\_\_\_  
6. Signature: Hideki HIRAYAMA

\_\_\_\_\_  
Date

\_\_\_\_\_  
7. Signature: Ryuichiro KAMIMURA

\_\_\_\_\_  
Date

\_\_\_\_\_  
8. Signature: Yamato OSADA

\_\_\_\_\_  
Date

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9. Signature: Satoshi SHIMATANI

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DEEP ULTRA VIOLET LED AND METHOD FOR MANUFACTURING THE SAME, and which has been given application serial number PCT/JP2014/078308;

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NOW, THEREFORE, for and in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign, and transfer to the ASSIGNEE, its successors, legal representative and assigns, the entire right, title and interest for the United States in and to the invention disclosed in said application, and in and to said application, as well as to all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents of the United States to issue all Letters Patent for said invention to the ASSIGNEE of the entire right, title and interest in and to the same, in accordance with the terms of this instrument.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to the UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns, the entire right, title and interest in and to the said invention, patent applications, Letters Patent, rights, titles, benefits, privileges, and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by the UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

\_\_\_\_\_  
1. Signature: Yukio KASHIMA

\_\_\_\_\_  
Date

\_\_\_\_\_  
2. Signature: Eriko MATSUURA

\_\_\_\_\_  
Date

Mitsunori Kokubo

January 27, 2015

3. Signature: Mitsunori KOKUBO

\_\_\_\_\_  
Date

Takaharu Tashiro

Jan. 26, 2015

4. Signature: Takaharu TASHIRO

\_\_\_\_\_  
Date

Takafumi Ookawa

Jan. 22, 2015

5. Signature: Takafumi OOKAWA

\_\_\_\_\_  
Date

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6. Signature: Hideki HIRAYAMA

\_\_\_\_\_  
Date

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7. Signature: Ryuichiro KAMIMURA

\_\_\_\_\_  
Date

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5. Signature: Takafumi OOKAWA

\_\_\_\_\_  
Date

Hideki Hirayama  
6. Signature: Hideki HIRAYAMA

Jan. 26, 2015  
Date

\_\_\_\_\_  
7. Signature: Ryuichiro KAMIMURA

\_\_\_\_\_  
Date

\_\_\_\_\_  
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\_\_\_\_\_  
Date

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Date

*Ryuichiro Kamimura*

*Jan. 22, 2015*

7. Signature: Ryuichiro KAMIMURA

Date

*Yamato Osada*

*Jan. 22, 2015*

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Date

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Date

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wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign, and transfer to the ASSIGNEE, its successors, legal representative and assigns, the entire right, title and interest for the United States in and to the invention disclosed in said application, and in and to said application, as well as to all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents of the United States to issue all Letters Patent for said invention to the ASSIGNEE of the entire right, title and interest in and to the same, in accordance with the terms of this instrument.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to the UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns, the entire right, title and interest in and to the said invention, patent applications, Letters Patent, rights, titles, benefits, privileges, and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by the UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

\_\_\_\_\_  
1. Signature: Yukio KASHIMA

\_\_\_\_\_  
Date

\_\_\_\_\_  
2. Signature: Eriko MATSUURA

\_\_\_\_\_  
Date

\_\_\_\_\_  
3. Signature: Mitsunori KOKUBO

\_\_\_\_\_  
Date

\_\_\_\_\_  
4. Signature: Takaharu TASHIRO

\_\_\_\_\_  
Date

\_\_\_\_\_  
5. Signature: Takafumi OOKAWA

\_\_\_\_\_  
Date

6. Signature: Hideki HIRAYAMA

Date

7. Signature: Ryuichiro KAMIMURA

Date

8. Signature: Yamato OSADA

Date

Satoshi SHIMATANI  
9. Signature: Satoshi SHIMATANI

2/2/2015  
Date